



### EHP-5393/UT31C-P01

#### **Features**

- Popular 10mm package.
- Typical color temperature 6500K
- View angle:25°.
- High light flux output
- Soldering methods: Dip soldering.
- Grouping parameter: total luminous flux, color coordinates.
- Optical efficiency: 30 lm/W
- Thermal resistance (junction to lead): 13K/W
- The product itself will remain within RoHS compliant version.
- ESD-withstand voltage: up to 4KV



- The series is specially designed for applications requiring higher brightness.
- EHP-5393 is a revolution, energy efficient and ultra compact new light source, combining the lifetime and reliability advantages of Light Emitting Diodes with the brightness of conventional lighting.

## **Applications**

- Flash
- Sunshine light.
- Advertising Signs.
- Back lighting.

### **Device Selection Guide**

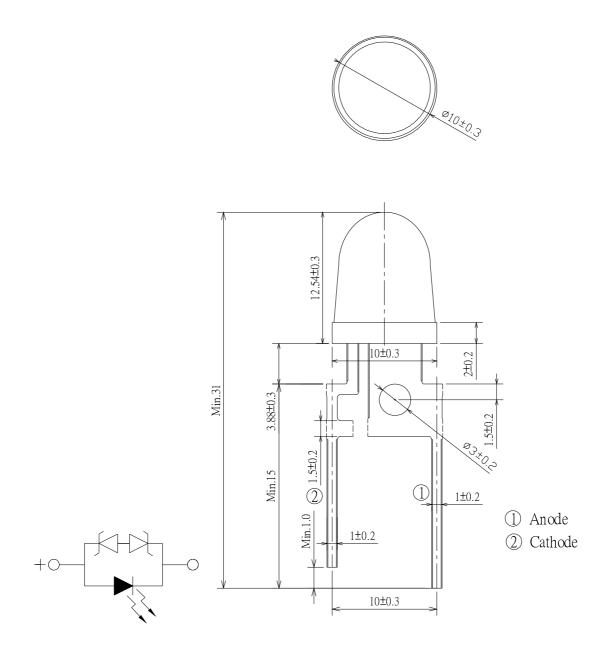
| I ED D. 4 N.       | Cł       | Chip                   |             |  |  |
|--------------------|----------|------------------------|-------------|--|--|
| LED Part No.       | Material | Material Emitted Color |             |  |  |
| EHP-5393/UT31C-P01 | InGaN    | White                  | Water Clear |  |  |





# EHP-5393/UT31C-P01

## **Package Dimensions**



### **Notes:**

- Other dimensions are in millimeters, tolerance is 0.25mm except being specified.
- Protruded resin under flange is 1.5mm Max LED.
- Bare copper alloy is exposed at tie-bar portion after cutting.

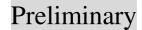
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# Absolute Maximum Rating ( $T_a=25^{\circ}C$ )

| Parameter                                | Symbol           | Absolute Maximum Rating | Unit                    |
|--|------------------|-------------------------|-------------------------|
| Forward Current                          | $I_{\mathrm{F}}$ | 350                     | mA                      |
| Junction to heat-sink thermal resistance | $R_{th}$         | 13                      | K/W                     |
| Operating Temperature                    | Topr             | -40 ~ +85               | $^{\circ}\! \mathbb{C}$ |
| Storage Temperature                      | $T_{stg}$        | -40 ~ +100              | $^{\circ}\! C$          |
| Electrostatic Discharge                  | ESD              | 4K                      | V                       |
| Soldering Temperature                    | $T_{sol}$        | 260                     | $\mathring{\mathbb{C}}$ |
| Power Dissipation                        | P <sub>d</sub>   | 1.4                     | W                       |
| Reverse Voltage                          | $V_R$            | 5                       | V                       |
| Zener Reverse Current                    | Iz               | 100                     | mA                      |

Notes: Soldering time ≤ 5 seconds.

# Electro-Optical Characteristics (T<sub>a</sub>=25°C)

| Parameter             | Symbol           | Min.                 | Тур. | Max.  | Unit                  | Condition             |  |
|-----------------------|------------------|----------------------|------|-------|-----------------------|-----------------------|--|
| Luminous Flux         | Flux             | 33                   |      | 52    | lm                    |                       |  |
| Viewing Angle         | $2\theta_{1/2}$  | θ <sub>1/2</sub> deg |      | deg   | I <sub>F</sub> =350mA |                       |  |
| Forward Voltage       | $V_{\mathrm{F}}$ | 3.0                  | 3.5  | 4.0   | V                     | 1                     |  |
| Reverse Current       | $I_R$            |                      |      | 10    | μΑ                    | V <sub>R</sub> =5V    |  |
| Zener Reverse Voltage | Vz               | 5.2                  |      |       | V                     | Iz=5mA                |  |
| Color Temperature     | CCT              | 4500                 | 6500 | 10000 | K                     | I <sub>F</sub> =350mA |  |
| Chromaticity          | X                |                      | 0.29 |       |                       | I <sub>F</sub> =350mA |  |
| Coordinates           | y                |                      | 0.28 |       |                       | IF-330IIIA            |  |

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# Preliminary

# EHP-5393/UT31C-P01

Rank Combination ( $I_F$ =350mA)

| Rank          | Ј3    | J4    | J5    | <b>K</b> 1 |
|---------------|-------|-------|-------|------------|
| Luminous Flux | 33~39 | 39~45 | 45~52 | 52~60      |

<sup>\*</sup>Measurement Uncertainty of Luminous Intensity: ±15%

Unit:mcd

Forward Voltage Combination (V at 350mA)

| Rank            | 1       | 2       | 3       | 4       | 5       |
|-----------------|---------|---------|---------|---------|---------|
| Forward Voltage | 3.0~3.2 | 3.2~3.4 | 3.4~3.6 | 3.6~3.8 | 3.8~4.0 |

<sup>\*</sup>Measurement Uncertainty of Forward Voltage: ±0.1V

Unit:V

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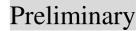
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# Color Combination ( at 350mA)

| Ye     | 5-1     | Y9-1     |       |  |
|--------|---------|----------|-------|--|
| X      | Y       | X        | Y     |  |
| 0.283  | 0.284   | 0.29     | 0.27  |  |
| 0.274  | 0.301   | 0.283    | 0.284 |  |
| 0.281  | 0.309   | 0.289    | 0.291 |  |
| 0.289  | 0.291   | 0.295    | 0.276 |  |
| Refere | nce CCT | • 9000~1 | 0000K |  |

| Ye     | 5-2      | Y9-2      |       |  |
|--------|----------|-----------|-------|--|
| X      | Y        | X         | Y     |  |
| 0.289  | 0.291    | 0.295     | 0.276 |  |
| 0.281  | 0.309    | 0.289     | 0.291 |  |
| 0.29   | 0.318    | 0.297     | 0.3   |  |
| 0.297  | 0.3      | 0.302     | 0.283 |  |
| Refere | ence CCT | T: 8000~9 | 9000K |  |

| Ye     | 5-3      | Y9-3      |       |  |
|--------|----------|-----------|-------|--|
| X      | Y        | X         | Y     |  |
| 0.308  | 0.311    | 0.311     | 0.293 |  |
| 0.297  | 0.3      | 0.302     | 0.283 |  |
| 0.29   | 0.318    | 0.297     | 0.3   |  |
| 0.303  | 0.333    | 0.308     | 0.311 |  |
| Refere | ence CCT | T: 7000~8 | 8000K |  |

| X     | X4    |       | X5          |             | X6    |       | .7    |
|-------|-------|-------|-------------|-------------|-------|-------|-------|
| X     | Y     | X     | Y           | X           | Y     | X     | Y     |
| 0.301 | 0.342 | 0.305 | 0.322       | 0.308       | 0.311 | 0.308 | 0.311 |
| 0.314 | 0.355 | 0.303 | 0.333       | 0.305       | 0.322 | 0.317 | 0.32  |
| 0.315 | 0.344 | 0.315 | 0.344       | 0.316       | 0.333 | 0.319 | 0.3   |
| 0.303 | 0.333 | 0.316 | 0.333       | 0.317       | 0.32  | 0.311 | 0.293 |
|       |       | Ret   | ference CCT | T: 6300~700 | 0K    |       |       |

| W     | /4    | W     | 75    | W        | 76        | W7    |       | W8    |       |
|-------|-------|-------|-------|----------|-----------|-------|-------|-------|-------|
| X     | Y     | X     | Y     | X        | Y         | X     | Y     | X     | Y     |
| 0.329 | 0.369 | 0.329 | 0.345 | 0.329    | 0.345     | 0.329 | 0.331 | 0.329 | 0.321 |
| 0.329 | 0.357 | 0.316 | 0.333 | 0.329    | 0.331     | 0.329 | 0.32  | 0.329 | 0.31  |
| 0.315 | 0.344 | 0.315 | 0.344 | 0.317    | 0.32      | 0.318 | 0.31  | 0.319 | 0.3   |
| 0.314 | 0.355 | 0.329 | 0.357 | 0.316    | 0.333     | 0.317 | 0.32  | 0.318 | 0.31  |
|       | •     | •     | Refer | ence CC7 | T: 5650~6 | 300K  | •     | •     |       |

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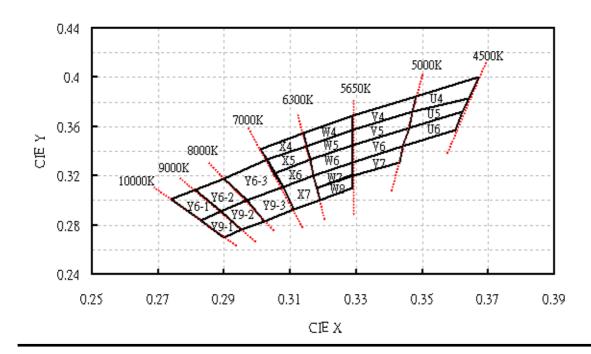


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| V     | V4                        |       | V5    |       | V6    |       | 77    |  |  |
|-------|---------------------------|-------|-------|-------|-------|-------|-------|--|--|
| X     | Y                         | X     | Y     | X     | Y     | X     | Y     |  |  |
| 0.329 | 0.357                     | 0.329 | 0.345 | 0.329 | 0.331 | 0.329 | 0.331 |  |  |
| 0.329 | 0.369                     | 0.329 | 0.357 | 0.329 | 0.345 | 0.344 | 0.344 |  |  |
| 0.348 | 0.385                     | 0.347 | 0.372 | 0.346 | 0.359 | 0.343 | 0.331 |  |  |
| 0.347 | 0.372                     | 0.346 | 0.359 | 0.344 | 0.344 | 0.329 | 0.32  |  |  |
|       | Reference CCT: 5000~5650K |       |       |       |       |       |       |  |  |

| U     | J <b>4</b> | U             | 15            | U6    |       |  |
|-------|------------|---------------|---------------|-------|-------|--|
| X     | Y          | X             | Y             | X     | Y     |  |
| 0.364 | 0.383      | 0.364         | 0.383         | 0.362 | 0.372 |  |
| 0.367 | 0.4        | 0.362         | 0.372         | 0.36  | 0.357 |  |
| 0.348 | 0.385      | 0.346         | 0.359         | 0.344 | 0.344 |  |
| 0.347 | 0.372      | 0.347         | 0.372         | 0.346 | 0.359 |  |
|       |            | Reference CC7 | T: 4500~5000K |       |       |  |

# **CIE Chromaticity Diagram**



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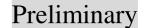
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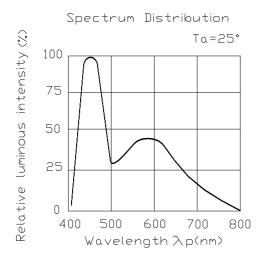
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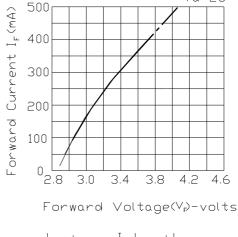




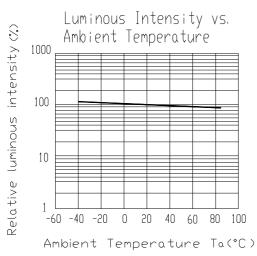
## EHP-5393/UT31C-P01

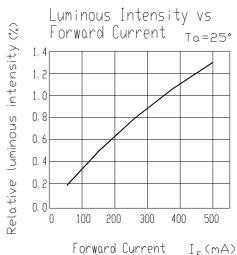
## **Typical Electro-Optical Characteristics Curves**

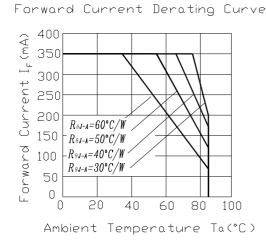


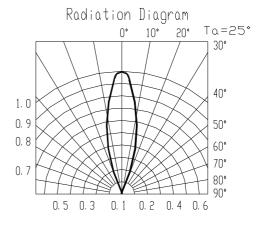


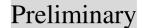
Forward Voltage









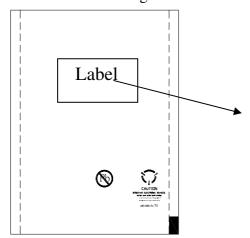




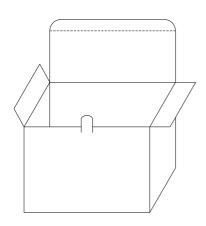
## EHP-5393/UT31C-P01

### **Packing Specification**

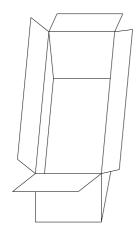
Anti-electrostatic bag



Inner Carton



Outside Carton



Label Form Specification

CPN: Customer's Production Number

P/N: Production Number QTY: Packing Quantity

CAT: Ranks of Total Flux and Forward Voltage

HUE: Color Rank REF: Reference

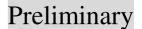
LOT No: Lot Number

MADE IN TAIWAN: Production Place

Packing Quantity

1. 250 PCS/1 Bag , 5 Bags/1 Inner Carton

2. 10 Inner Cartons/1 Outside Carton





# EHP-5393/UT31C-P01

### **Notes**

### 1. Lead Forming

- During lead formation, the leads should be bent at a point at least 3mm from the base of the epoxy bulb.
- Lead forming should be done before soldering.
- Avoid stressing the LED package during leads forming. The stress to the base may damage the LED's characteristics or it may break the LEDs.
- Cut the LED leadframes at room temperature. Cutting the leadframes at high temperatures may cause failure of the LEDs.
- When mounting the LEDs onto a PCB, the PCB holes must be aligned exactly with the lead position of the LED. If the LEDs are mounted with stress at the leads, it causes deterioration of the epoxy resin and this will degrade the LEDs.

#### 2. Storage

- The LEDs should be stored at 30°C or less and 70%RH or less after being shipped from Everlight and the storage life limits are 3 months. If the LEDs are stored for 3 months or more, they can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material.
- Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.

#### 3. Soldering

- Careful attention should be paid during soldering. When soldering, leave more then 3mm from solder joint to epoxy bulb, and soldering beyond the base of the tie bar is recommended.
- Recommended soldering conditions:

| Hand Soldering       |                      | DIP Soldering     |                       |
|----------------------|----------------------|-------------------|-----------------------|
| Temp. at tip of iron | 300°C Max. (30W      | Preheat temp.     | 100°C Max. (60 sec    |
|                      | Max.)                |                   | Max.)                 |
| Soldering time       | 3 sec Max.           | Bath temp. & time | 260 Max., 5 sec Max   |
| Distance             | 3mm Min.(From solder | Distance          | 3mm Min. (From solder |
|                      | joint to epoxy bulb) |                   | joint to epoxy bulb)  |

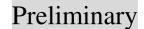
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- Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.
- Dip and hand soldering should not be done more than one time
- After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- Although the recommended soldering conditions are specified in the above table, dip or handsoldering at the lowest possible temperature is desirable for the LEDs.
- Wave soldering parameter must be set and maintain according to recommended temperature and dwell time in the solder wave.

#### 4. Cleaning

- When necessary, cleaning should occur only with isopropyl alcohol at room temperature for a duration of no more than one minute. Dry at room temperature before use.
- Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence
  of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the
  assembled condition. Ultrasonic cleaning shall be pre-qualified to ensure this will not
  cause damage to the LED

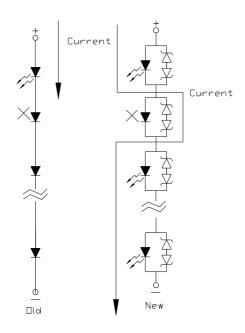
### 5. Circuit Protection

- Below the zener reference voltage Vz, all the current flows through LED and as the voltage rises to Vz, the zener diode "breakdown." If the voltage tries to rise above Vz current flows through the zener branch to keep the voltage at exactly Vz.
- When the LED is connected using serial circuit, if either piece of LED is no light up but current can't flow through causing others to light down. In new design, the LED is parallel with zener diode. if either piece of LED is no light up but current can flow through causing others to light up.

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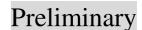


### 6. Heat Management

- Heat management of LEDs must be taken into consideration during the design stage of LED application. The current should be de-rated appropriately by referring to the de-rating curve found in each product specification.
- The temperature surrounding the LED in the application should be controlled. Please refer to the data sheet de-rating curve.
- If the emitter is operated, consider using metal heat sink with the lowest possible thermal resistance. For the thermal performance using a flat heat sink, allow an exposed surface area of about 25mm<sup>2</sup> at least.

### 7. ESD (Electrostatic Discharge)

- Electrostatic discharge (ESD) or surge current (EOS) can damage LEDs.
- An ESD wrist strap, ESD shoe strap or antistatic gloves must be worn whenever handling LEDs.
- All devices, equipment and machinery must be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing.





## EHP-5393/UT31C-P01

#### 8. Other

- Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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